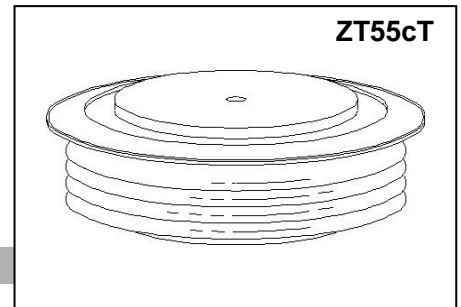




GENERAL PURPOSE HIGH POWER STANDARD RECTIFIER

Features:

- . All Diffused Structure
- . High Surge rating
- . Blocking capability up to 1600 volts
- . Ceramic Housing Hermetic Package
- . Pressure Assembled Device



ELECTRICAL CHARACTERISTICS AND RATINGS

Reverse Blocking

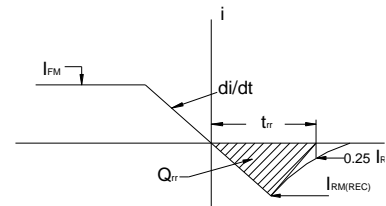
Device Type	V _{RRM} (1)	V _{RSM} (1)
ZP2500-06	600	800
ZP2500-08	800	1000
ZP2500-10	1000	1200
ZP2500-12	1200	1400
ZP2500-14	1400	1600
ZP2500-16	1600	1800

V_{RRM} = Repetitive peak reverse voltage
 V_{RSM} = Non repetitive peak reverse voltage (2)

Repetitive peak reverse leakage	I _{RRM}	5 mA 60 mA (3)
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Notes:

- All ratings are specified for T_j=25 °C unless otherwise stated.
- (1) All voltage ratings are specified for an applied 50Hz/60Hz sinusoidal waveform over the temperature range 0 to +175 °C.
 - (2) 10 msec. max. pulse width
 - (3) Maximum value for T_j = 175 °C.
 - (4) See parameter definition below :



REVERSE RECOVERY CHARACTERIST

Conducting - on state

Parameter	Symbol	Min.	Max.	Typ.	Units	Conditions
Average forward current	I _{F(AV)}		2500		A	Sinewave, 180°, T _c =100 °C
RMS forward current	I _{FRMS}		3925		A	Nominal value
Peak one cycle surge (non repetitive) current	I _{FSM}		27500		A	10 msec (50Hz), sinusoidal wave-shape, 180° conduction, T _j = 175 °C
I square t	I ² t		3.8 × 10 ⁶		A ² s	10 msec
Peak forward voltage	V _{FM}		1.35		V	I _{FM} = 3000A; T _j =25°C
Threshold voltage	V _{FO}		0.78		V	T _j =175°C, I=0.5 π I _{F(AV)} to 1.5 π I _{F(AV)}
Slope resistance	r _F		0.094		mΩ	T _j =175°C, I=0.5 π I _{F(AV)} to 1.5 π I _{F(AV)}
Reverse Recovery Current (4)	I _{RM(REC)}				A	I _{FM} = 500 A; di/dt = -10 A/s; T _{jmax}
Reverse Recovery Charge (4)	Q _{rr}			4000	μC	I _{FM} = 500 A; di/dt = -10 A/s; T _{jmax}
Reverse Recovery Time (4)	t _{rr}				μs	I _{FM} = 500 A; di/dt = -10 A/s; T _{jmax}

Parameter	Symbol	Min.	Max.	Typ.	Units	Conditions
Operating temperature	T_j	-40	+175		°C	
Storage temperature	T_{stg}	-40	+175		°C	
Thermal resistance - junction to case	$R_{\Theta(j-c)}$		0.022		°C/W	Double sided cooled
Thermal resistance - case to heatsink	$R_{\Theta(c-s)}$		0.005		°C/W	Double sided cooled
Mounting force	P	22	27	25	kN	
Weight	W			0.46	kg.	

* Mounting surfaces smooth, flat and greaseless

CASE OUTLINE AND DIMENSIONS

